Microstructure and Microhardness of Directionally Solidified Al-Si Alloys Subjected to an Equal-Channel Angular Pressing Process

Roberto Carlos Sales*, Leonardo de Olivé Ferreiraa, Rangel de Paula Almeidaa, Bráulio Pinto Terra*,
Lucas Jardim de Mouraa, Alexandre Furtado Ferreira***

aUniversidade Federal Fluminense, Programa de Pós-Graduação em Engenharia Metalúrgica, 27253-125, Volta Redonda, RJ, Brasil.
bUniversidade Federal do ABC, Grupo de Engenharia Aeroespacial, 98010-000, São Bernardo do Campo, SP, Brasil.

Received: July 07, 2021; Revised: September 06, 2021; Accepted: October 08, 2021

The directional solidification technique allows the study of growth of the solid phase, as-cast structure and, finally, its mechanical characteristics as a consequence of thermal parameters. On the other hand, in the last decade, a process called equal-channel angular pressing (ECAP) has emerged as a widely-known technique in fabrication of ultrafine-grained metals and alloys. Applicability of the ECAP technique affords an excellent potential for changing, in a controlled and beneficial manner, the resulting properties of metals and alloys. For this paper, an experimental research has been conducted to study the effects of solidification parameter (cooling rate) on resulting microhardness in hypoeutectic Al-Si alloys, upon use of an ECAP procedure. The influence of cooling on the scale of the dendritic patterns is presented and discussed with recourse to equations. The resulting microhardness variation with position throughout the as-cast materials and cooling rate were characterized by experimental power laws. Results determined after the solidification experiments have revealed microhardness as a function of both cooling rate and position (P) of the as-cast materials to be dependent on alloy composition. In the ECAP process via route C with three passes, “as-solidified” microstructures have been found to be distorted and fragmented during the severe plastic deformation. This deformation imposed on the billets during the ECAP process facilitated obtaining a fine microstructure and high levels of microhardness were observed. However, even with the ECAP process, it was shown that microhardness is strongly dependent of the cooling rates.

Keywords: Equal-channel angular pressing, ultrafine-grained alloys, microhardness, solidification.

1. Introduction

Only in the last decades, experiments involving directional solidification with pure metals and their alloys have come into attention. The mentioned technique allows a study of the growth of the solid and microstructure as a function of the solidification variables, making it a very attractive technique for investigation of these variables in solidification of metals and alloys. When directional solidification is upward, the melt, rich in segregated solute, with a higher density as compared to the alloy melt, flows downward and the convection phenomenon is mostly confined between the dendrite arms, since the thermal gradient tends to stabilize density stratification in the melt. This may lead to dendritic fragmentation to accommodate high solute concentration in the interdendritic regions.

Hypoeutectic ternary systems have been adopted by Baptista et al., Costa et al., Rocha et al. and Ferreira et al. with the purpose of studying the influence of thermal parameters on the microstructural development and microsegregation. Al–9 wt.% Si–2 wt.% Cu and Al–9 wt.% Si–4 wt.% Cu alloys were unidirectionally solidified by Baptista et al., with transient heat flow in a cooling range of 0.2 to 9 °C/sec. Experimental equations associating tertiary dendrite spacing with the thermal parameters were determined, showing that the increase in Cu content has induced an increase in dendrite arm spacing.

Recently, Sales et al. investigated the influence of thermal parameters on dendrite arm spacing and mechanical properties in Al-Si alloys directionally solidified. Characterization analyses indicated that there is an increase in dendritic arm spacing with the reduction in solidification speed and cooling rate during the solidification. Differently, experimental data obtained by Sales et al., have shown an increase in hardness as the solidification-process parameters are gradually increased.

Over the last ten years, a procedure has emerged for obtaining ultrafine-grained metals and alloys known as equal-channel angular pressing. Basically, the ECAP technique consists in pushing a thick metal stick through a two directional matrix both of whose channels have identical cross sections intersecting at an angle φ. They feature an additional angle R, which defines the curvature of the intersection exterior to the channels. As the material progresses along the inside of the channels, it undergoes

*e-mail: alexandrefurtado@id.uff.br
simple shearing-type plastic deformation, thereby being able to develop a new microstructure, with an also new crystallographic texture. The channel has two parts with equal cross-section on either side of the bend, which favors emergence of high shearing-strain specimens from the die and no changes on their cross-sectional dimensions. Therefore, the specimens of metals or alloys can be pressed repetitively through the die in order to attain exceptionally high strains.

Garcia-Infanta et al. investigated a hypoeutectic Al–7 wt.% Si alloy subjected to ECAP process up to eight passes via routes A, B, Bc and C. No significant differences in tensile strength were found by authors, between the processed samples. However, there are differences in ductility of samples, which are attributed to the dependence of the fracture propagation path on the processing route due to different geometric redistribution of the eutectic region.

Microstructures resulting from ECAP process of Al-Si alloy by different processing routes were investigated by García-Infanta et al. In that experimental work, an Al–7 wt.% Si alloy was subjected to ECAP using a 90° die at room temperature for two different routes (A and Bc). The authors concluded that shapes changes of the microstructure mirror the straining for repetitive processing by these routes. Thus, the morphology and distribution of the eutectic constituent in processed samples reflect geometrical effects, although elongated Si and Al5FeSi particles in the eutectic are also broken up. Grain refinement in the primary Al constituent is also strain-path dependent: grain subdivision combined with geometric effects is operative in samples processed by route A, while grain subdivision alone predominates in samples processed via route Bc.

Swaminathan et al. have investigated the effects of the different ECAP processing routes on the microstructures and mechanical properties in a hypoeutectic Al-Si alloy. As-cast alloy billets were subjected to deformation by ECAP employing routes: A, B, Bc, and C. The observed microstructures suggest homogenization of the eutectic constituents via a progressive decrease in the widths of the primary Al dendritic cells, while straining results in microstructure resembling the as-cast microstructure with no homogenization after two and four passes in routes C and Bc, respectively.

Experiments were conducted by Duan et al. in order to evaluate the potential for producing some degree of homogeneity when processing by ECAP with a special split die having a channel angle of 90°. Using high-purity aluminum, measurements of the Vickers microhardness were recorded over cross-sectional planes after pressing through one to four passes. It was found that there is less homogeneity after one or two passes by comparison with conventional ECAP die. The results demonstrate a die with two equal arcs of curvature is less effective than a conventional ECAP die for producing homogeneity within the billets.

Over the years, regarding either vertical unidirectional solidification or equal-channel angular pressing experiments, sundry works have focused on the resulting microstructure. Since microstructure control is a key factor in generating excellent properties in metals and their alloys, determination of parameters which can affect said microstructures is of primary importance. It is in this general framework that the present work is elaborated, emphasizing the influence of cooling rates during vertical upward transient directional solidification on the "as-cast" microstructure and microhardness before and after equal-channel angular pressing of hypoeutectic Al-Si alloys.

2. Materials and Methods

A flowchart of the experimental procedure for unidirectional solidification with processing by means of ECAP is given in Fig. 1.

The variables show in Fig. 1, are defined as: λ is secondary dendrite arm spacing (μm), Sr represents solidification speed (mm/s), T is cooling rate (°C/s), Ls1 is local solidification time (s), Hv1 are of microhardness values (Hv) before the ECAP process, Π is position along the ingot (mm) and finally the Hv2 is microhardness obtained after ECAP process (HV).

The experimental technique adopted for transient vertical upward directional solidification was previously described in greater detail in Refs. [1, 6, 11, 15]. The solidification apparatus which favors heat extraction from the bottom of the mold is depicted in Fig. 2.

The binary alloys used in our experiments were produced from aluminium (99.9% Al) and silicon (99.9% Si) in a muffle furnace. Their chemical composition was measured using fluorescence X-ray spectrometry. The molten alloys were poured into a mold for determination of the cooling curves during solidification experiments with an unsteady-state regime of heat extraction. The bottom part of the mold was closed with a thin (3 mm) carbon steel sheet. The initial temperature of the solidification apparatus and molten alloys were standardized at 740 °C. Temperature mapping during our binary-alloy solidification experiments was carried out by recourse to thermocouples located at eight different points, positioned at 5, 10, 15, 20, 35, 45, 60 and 85 mm from the mold opening in greater detail in Refs. [1, 6, 11, 15]. The solidification apparatus and its cooling system were previously described and can be observed in Fig. 2.

Figure 1. Flowchart of the experiments.
from the refrigerated base. It is important to highlight those thermocouples maintained their initial position during the solidification experiments. These thermocouples were connected to a high-speed data logger and, therefore, able to generate real-time thermal profiles. Temperature data were sampled at 0.01 seconds intervals by a data-logging interface and stored in a personal computer.

Cooling rates can be determined from temperature and time values recorded after the passing of the liquidus front by each thermocouple. Transverse specimens were cut from positions close to each thermocouple tip, with the purpose of obtaining a relationship between solidification parameters, dendrite-arm spacing, and microhardness. The specimens were polished with abrasive paper and then etched with a solution of 0.5% HF, for further microstructural analysis.

An Olympus Optical Microscope (Olympus Corporation, Japan) was used to produce digital images that were analyzed using the Goitaca (https://sourceforge.net/projects/goitacaeq) image processing software in order to measure the dendritic spacings. Dendritic spacing usually refers to the space between primary arms of the dendrites. However, if secondary arms are present, the spacing will be referred to as their smaller dimensions become more significant for the properties of the material, as discussed by Paradela et al. For each specimen, secondary-dendrite spacings were determined by averaging the distance between adjacent side branches. The average dendritic arm spacings were determined from about 40–45 measurements for each examined position along the entire die-casting. The secondary dendrite arm spacing \( \lambda_2 \) was measured on the transverse sections of each sample by using the linear intercept method. Microhardness tests was performed in at least twelve different positions on the transverse section. A loading time of 15 seconds, as well as load of 100 g, were used in a Vickers pyramidal indenter.

Transverse specimens were cut from the castings and prepared for equal channel angular pressing (ECAP). A schematic to illustrate the obtention of the billets from the directionally solidified ingots is given in Fig. 3.

Figure 2. Diagrammatic representation of equipment: (1) personal computer and data-acquisition software; (2) data-logging hardware; (3) temperature-control system; (4) K thermocouples; (5) crucible; (6) melt; (7) unidirectional solidification furnace; (8) electric heaters; (9) ceramic fiber insulation; (10) steel mold; (11) steel plate; (12) water-cooled bottom; (13) water pump (Ferreira et al.).

Figure 3. Schematic to illustrate the obtention of the billets from the solidified ingots.

Aluminium alloys used in this investigation were pressed using an experimental facility for ECAP installed in the Laboratory of Mechanical Tests of the Federal Fluminense University, Fig. 4a.

The ECAP was conducted mostly at room temperature, on an EMIC-600 universal testing machine equipped with a 600 kN load cell and die that have an internal 90° angle between two parts of the channel and outer arc of curvature of some 37°, where the two parts intersect. The ECAP die required use of billets with 60 mm in length and square cross section of 10 mm x 10 mm. The speed of the plunger was 5 mm/min. The processing route used in our experiments was route C, with three passes. In the case of processing by Route C (rotations of 180° and three passes), the microstructures resulting from ECAP process, are similar to that of the as-cast microstructure and consist of equiaxed primary dendritic cells, according to Swaminathan et al. The specimens were rotated by 180° around the vertical direction between passes, as depicted in Fig. 4c. Repetitive pressing provides a choice opportunity of different slip systems on each consecutive pass by simply rotating the specimens in different ways.

Figure 4. Equal-channel angular pressing (ECAP): a) Adaptation of the universal testing machine EMIC-600 for pressing via ECAP, b) Parts of ECAP with pressed sample and c) Schematic representation of route C with three passes.
The distinction between these routes and the difference in number of ECAP passes may lead to variations both in the macroscopic distortions of the grains and in the capability to develop a reasonably homogeneous and equiaxed ultrafine-grained microstructure, Furukawa et al.$^{32}$

### 3. Results and Discussion

The present work is divided into two parts. The first part is focused on solidification analysis of Al - 3 wt. % Si and Al - 7 wt. % Si alloys, and second part deals with analysis of the as-cast alloys after ECAP process.

#### 3.1. Solidification analysis of Al - 3 wt. % Si and Al - 7 wt. % Si alloys

Figure 5 exhibits the phase diagram of the system of alloys investigated, computed with help of a well-known thermodynamics software package$^{33}$.

For aluminum alloys with 3 wt. % Si and 7 wt. % Si, during cooling the solidification process is started with liquidus temperature of 642°C and 615°C, respectively, as shown in Fig. 5, emphasizing the liquid-solid transformation region. In that figure, both hypereutectic and hypoeutectic regions are displayed and the limit of silicon solubility in the solid phase is in evidence at 1.6 wt. % Si at a given temperature of 577°C. On the other hand, Figs. 6a and 6b exhibit the cooling profiles obtained in the course of our solidification experiments.

As evinced in Figs. 6a and 6b, temperature profiles quickly decrease at positions close to the mold base and then moderately decrease in the direction of solidification completion. One of the thermocouples was placed 5 mm from the mold base and the others were positioned at 10, 15, 20, 35, 45, 60 and 85 mm away from the base. These cooling profiles are similar to those found by Baptista et al.$^{11}$ and Paradela et al.$^{29}$, showing small plateaux close to liquidus temperature. The pouring temperatures were set up at about 740°C, in both cases.

The thermal parameters, such as $S$ and $T$, were determined from the cooling profiles (Figs. 6a and 6b) measured by a high-speed data logger. The $S$ is experimentally calculated as $S = \frac{dP}{dt}$, as suggested by Paradela et al.$^{29}$. The cooling rate, on the other hand, is determined, for each position of the thermocouples, as $T = \frac{dT}{dt}$, consistent with both Baptista et al.$^{11}$ and Sales et al.$^{15}$. Through the cooling profiles, the position of the liquidus temperature ($T_L = 642°C$ and $T_L = 615°C$) was determined as a function of time by regression of the experimental data, as depicted in Figs. 7a and 7b.

From this function ($P=f(t)$), the value of $S$ was determined as a function of the time by computing the time derivative of $P$. Figures 7a and 7b display these results, also. Regrouping both equations ($P=f(t)$ and $S=f(t)$), an equation of $S$, position-dependent, can be found, as depicted in Fig. 8, where $S$ is plotted against $P$.

**Figure 5.** Phase diagram of Al-Si system as computed with the Thermo-Calc Software$^{11}$ with Aluminum Database v4.0.

**Figure 6.** Temperature profiles for each position of the thermocouples: a) Al - 3 wt. % Si alloy, and b) Al - 7 wt. % Si alloy.
Microstructure and Microhardness of Directionally Solidified Al-Si Alloys Subjected to an Equal-Channel Angular Pressing Process

In both cases, the $S_S$ curve decreases faster in the positions close to the cooling base and becomes almost constant as one moves away from the base. This stems from the fact that the water-cooling system favors high $S_S$ in positions close to the mold bottom. On the other hand, the value of $S_S$ decreases along the casting, due to an increase in thermal resistance in the solidified region. We can see in Fig. 7 a slight discrepancy between the experimental profiles. The results suggest that the silicon addition to the aluminum alloy lead to a decrease in $S_S$. Analyzing the discrepancy between profiles, at the 5 mm position the $S_S$ found in the experiment with the Al-7 wt.% Si alloy is 11% lower than the speed found for the one with the Al-3 wt.% Si alloy, while at the 85 mm position this value is increased by about 25%. Experiments of solidification with water-cooled molds are very useful when high cooling rates are desired. Higher cooling rates yield rapid solidification, i.e., a short solidification time, which can affect beneficially the morphology of microstructure, such as grain size and dendritic spacing.

Cooling rate ($\dot{T}$) versus position ($P$) is displayed in Fig. 9. Once again, we can see a discrepancy in the experimental profiles, which indicates that the cooling rates are significantly influenced by changes in solute concentration, while preserving the same profiles along the casting length for both cases analyzed. Similar profiles were found by Baptista et al. and Sales et al. The $\dot{T}$ and solute concentration are factors acting in parallel with $S_S$ during the solidification experiments, which serves to condition the changes in structure and mechanical properties in as-cast materials.

As the solidification proceeds, a continuous increase of the local solidification time in different positions along the castings was observed, Fig. 10. One can see that the $L_{st}$ profile moves upward, with an increase in solute concentration, from 3 to 7 wt.% Si. Deviations between the solidification times arise because the solute concentration exerts an effect on $S_S$ and this parameter, in turn, can affect the local solidification time during solidification experiments. Comparative analysis of the profiles of the local solidification time and $S_S$ versus $P$, reveal that $S_S$ dwindles quickly at the region close to the mold bottom, followed by a gradual, slower decrease along castings. In contrast, an inverse trend can be observed in the local solidification times close to the bottom, $L_{st}$ increases faster; afterwards, it starts a gradual increase along castings. Higher $S_S$ favors rapid solidification, i.e., a short local solidification time. It is worth mentioning that as-cast alloys with wide solidification intervals make them susceptible to segregation phenomena during the procedure.

Secondary dendrite arm spacings ($\lambda_2$) for different $P$ and $\dot{T}$ are shown in Figs. 11a and 11b. The profiles depicted in Fig. 11a correspond to experimental functions obtained from experimental data for alloys considered in our experiments. The focal point of these experimental results was $\lambda_2$, which increases with $P$ in the course of the castings. However, increasing the silicon concentration (from 3 wt.% to 7 wt.% Si), changes in $\lambda_2$ can be observed. The next two profiles in Fig. 11b correspond to $\lambda_2$ as a function of $\dot{T}$. In that figure, the dashed curves come from experimental functions that were fitted to the experimental data. As can be seen, in both cases $\lambda_2$ is affected by $\dot{T}$, which is evidenced by the
experimental expressions. The profiles are in agreement with the published literature (Baptista et al.\(^1\), Sá et al.\(^3\,4\) and Carvalho et al.\(^35\)) and show the effect of \(\dot{T}\) on \(\lambda_2\). This effect translates to the microstructure growth, i.e., high values of \(\dot{T}\) near the mold bottom favor a more refined microstructure, whereas low values of this thermal parameter close to the top of the castings contribute effectively to yield a coarser microstructure.

The Vickers microhardness \((H_V)\) with load of 100 g, was also measured at all monitored points, after the solidification experiments. The \(H_V\) profiles through the castings are shown in Fig. 12a, where a variation of \(H_V\) values with the positions of casting can be observed. As expected, in positions near the cooling plate, an improvement in \(H_V\) is observed, due to the fine microstructure as a consequence of high values of \(\dot{T}\) and \(S_S\). These results \((H_V\) versus \(P\) and \(\dot{T}\)) are similar to those presented by Sales et al.\(^{15}\) and Paradela et al.\(^{29}\). As shown in Fig. 12a, for Al - 3 wt.% Si and Al - 7 wt.% Si alloys, the \(H_V\) decreased from 25.4 to 20.1 HV and from 35.4 to 27.3 HV, which confirms a reduction of about 21% and 23% along the castings, respectively. However, with an increase of solute concentration from 3 to 7 wt.% Si, alloy average \(H_V\) is increased from 22 to 31 HV, which shows a remarkable increase of about 29%. One can see in Fig. 12b that \(H_V\) is affected by microstructure resulting from \(\dot{T}\), which is evinced by two experimental functions, \(H_V = 21.17^{\dot{T}}.0.13\) and \(H_V = 33.44^{\dot{T}}.17\).
Microstructure and Microhardness of Directionally Solidified Al-Si Alloys Subjected to an Equal-Channel Angular Pressing Process

Higher cooling rates ($T$) are responsible for a decrease in secondary dendritic arm spacing ($\lambda_2$) and this parameter, in turn, favor an improvement in resulting microhardness at regions close to the cooling plate. Mechanical properties of as-cast alloys are strongly connected to their microstructures obtained after solidification. The effect $T$ has on the mechanical properties manifests itself by engendering a variety of microstructures with different morphologies and sizes. Higher $T$ leads to a reduction of microstructure and formation of as-cast alloys with high strength and hardness, because it suppresses atomic diffusion during solidification, Paradela et al. 29.

3.2. Analysis of the As-cast Alloys after ECAP process

Figure 13 depicted the as-cast microstructure of an Al-7 wt.% Si alloy before and after an operation of equal-channel angular pressing. One can see in Figs.13a through 13c that a dendritic-type microstructure prevailed along the entire casting. Below each micrograph information can be found concerning the position (P) from where the specimens were extracted in the casting, values of $\lambda_2$, $S_2$, $T$ and microhardness ($H_V$). On the other hand, Figs. 13d through 13e display the cast microstructure of our Al - 7 wt. % Si alloy after ECAP with three passes via route C.

As can be seen from these pictures, dendritic microstructures have distorted and fragmented morphology because of the imposed deformation. Figs. 13d through 13e also show the changes in $H_V$ in deformed specimens. It is clear from these images that the $H_V$ of any specimen considered increased after ECAP. This is a consequence of work hardening during ECAP of the as-cast alloy. In addition, the ECAP process using route C with three passes is recognized to favor material hardness. Using ECAP with a high number of passes, the breakdown of dendrites is more intensive and the size of these broken microstructures is finer, therefore the microhardness is increased in comparison to simply as-cast alloys. It is worth mentioning that, as a result of applied ECAP in the billets, the eutectic Si fibers are fragmented, dispersed and spheroidized in the matrix. This microstructural evolution favors higher mechanical properties, such as microhardness, as discussed by Haghshenas et al. 36. The microhardness of all previously mentioned specimens from our Al - 3 wt.%

![Figure 13. Dendritic microstructure of an Al–7 wt.% Si alloy before and after an operation of equal-channel angular pressing.](image-url)
Si and Al - 7 wt.% Si alloys (Fig. 12a), were compared with those obtained after application of ECAP.

Figs. 14a and 14b display the microhardness along the casting length, before and after ECAP.

It should be mentioned that the billets did not suffer significant deformation on its longitudinal section after ECAP process. Similar profiles have been observed for all the alloys examined, even after ECAP. It deserves highlight that in Al - 3 wt.% Si and Al - 7 wt.% alloys, the microhardness after ECAP with three passes increased its average values from 22 HV (before ECAP) to 29 HV (after ECAP) and from 31 HV (before ECAP) to 42 HV (after ECAP), respectively. Through an analysis of these experimental data, it can be concluded that after ECAP, the Al - 3 wt.% Si alloy had its average microhardness increased by about 24%, while the Al - 7 wt.% Si alloy shows an increase of 26%. We can see that the three-pass ECAP process had a greater effect on the microhardness of Al - 7 wt.% Si alloy than on the microhardness of the Al - 3 wt.% Si one. This finding can be attributed to the fact that in Al - 7 wt.% Si alloy case, a more intense grain refinement is achieved by ECAP process when compared to the Al - 3 wt.% Si alloy. Even after the ECAP process with three passes via route C, the microhardness profiles for both alloys are clearly nonlinear, with both curves roughly asymptotic to the horizontal axis of the plot.

As the results for microhardness suggest, even after ECAP, which is one of the most commonly employed severe-deformation processes to drive ultrafine-grained microstructure, the cooling rates (Ṫ) through initial microstructure, still exerts a strong effect on the mechanical properties of the as-cast material, as depicted in Figs. 15a and 15b.

Microhardness dependence on the cooling rate can be observed in those pictures, where variations of this mechanical property with Ṭ is presented. The dashed curves represent experimental functions which were fitted to the data. The microhardness variations in Al - 3 wt.% Si and Al - 7 wt.% Si alloys are characterized by 0.14 and 0.18 power laws, respectively. It is worth mentioning that present work highlights the manner by which the microstructure and microhardness (before and after ECAP process) of Al-Si alloys were affected by variation in the cooling rate obtained during the solidification experiments. The finer microstructures resulting from solidification experiments were observed under higher cooling rates. This rapid cooling hinders excessive growth of the microstructures, which favors a finer and even distribution of silicon deposits and also less solute segregation is favored during solidification. These factors, previously discussed, affect the microhardness of the as-cast Al-Si alloys, even after ECAP process, as observed in Figs. 15a and 15b.

4. Conclusions

A thorough analysis of our results revealed that the speed of solidification decreases faster in the positions near the water-cooled system and this speed becomes almost constant as moves away from the mold bottom. This behavior is due to an increase in the thermal resistance of the newly solidified
layers, which hampers heat extraction during solidification experiments.

A deviation between the profiles of solidification speed was observed, which suggests that an increase in silicon concentration in the tested alloys provoked a decrease of $S_L$. A similar behavior was noted in the $T$ versus $P$ plots, i.e., high values of cooling rate in positions near to mold bottom, followed by a gradual decrease with $P$ in the castings. Comparing, on the other hand, the $L_w$ versus $P$ and $S_L$ versus $P$ plots, $S_L$ is seen to decrease abruptly at the region close to mold bottom, followed by a gradual decrease along the castings. However, an opposite behavior can be observed for $L_w$, i.e., the thermal parameter increases from the region close to mold bottom. It seems reasonable to surmise that, owing to the amount of silicon added to the alloy being experimented with (from 3 to 7 wt.% Si) in order to operate as a limiting agent on the heat transfer throughout the casting process, the higher Si concentration can affect thermal parameters such as $S_L$, $T$ and $L_w$.

Post-solidification microhardness was also investigated. Results suggest that higher microhardness values can be obtained by the combined effect of higher $T$ and high silicon concentration. Specimens of the as-cast material were submitted to equal channel angular pressing with three passes via route $C$. In these particular experiments, microhardness was favored by the severe plastic deformation process. However, the microhardness profiles of both alloys are clearly nonlinear, both curves tending downwards as one moves away from the mold bottom. The results have pointed out that the cooling rate still exerts a strong effect on the microhardness, even after the as-cast material was submitted to equal-channel angular pressing.

5. Acknowledgments

The authors are grateful to FAPERJ (Fundação de Amparo à Pesquisa do Estado do Rio de Janeiro, APO#1: E-26/010.001942/2019) and CNPq (Conselho Nacional de Desenvolvimento Científico e Tecnológico, nº 305181/2019-0, PQ - 2019) for financial support.

6. References


